

PRODUCT SPECIFICATION

產品規格書

產品名稱 Description	產品料號 Part No.	圖號 Drawing No.
5090 Series Automotive Header 3.0X3.0mm(0.118"X0.118")	5090-2XxxTDx-xT-P	5090-DSxx-001

PRODUCT NAME 產品名稱	DOCUMENT No.: 文件編號	Rev. 版本	OUPIIN
5090 Series Automotive Header 3.0X3.0mm(0.118"X0.118")	Q5090-PSS-001	A	歐品電子
	Approved 核准	Checked 審核	Prepared 制作
			XS 07/03'23

1. COPE 適用範圍

This product specification defines the product performance and the test methods to ascertain the performance of the 5090 Series Automotive Header 3.0X3.0mm(0.118”X0.118”) Connector which is designed and manufactured by Oupiin Electronic Co., Ltd. This product specification is applicable but not only for those part numbers which be shown in the cover page.

本產品規格書規定了由歐品電子有限公司設計生產的 5090 Series Automotive Header 3.0X3.0mm (0.118”x0.118”) 型連接器，產品的特性及測試方法。本產品規格書適用於但不局限於封面所顯示的產品料號。

2. REFERENCE DOCUMENTS 參考文件

MIL-STD-1344A	Test method for electrical connector 電子連接器測試方法
MIL-STD-202	Test method for electrical components 電子零件測試方法
EIA364	Test method for electrical components 電子零件測試方法
JIS C 0051	Test method for electrical components 電子零件測試方法
MIL-G-45204C	Specification for gold plating 鍍金規格
IEC-512-3	IEC standard for current carrying capacity tests IEC電流測試標準
QQ-N-290A	Specification for nickel plating 鍍鎳規格
MIL-P-81728A	Specification for tin/lead plating 鍍錫鉛規格
MIL-T-10727B	Specification for tin plating 鍍錫規格
UL1977	UL Standard for safety of attachment plug and receptacle UL安規要求标准
EN/ISO5961	Determination of total lead & cadmium content 总铅和总镉含量測定
EN1122	Determination of total lead & cadmium content 总铅和总镉含量測定
EN13346	Determination of heavy metals content 重金属含量測定
EPA3052	Determination of total lead & cadmium content 总铅和总镉含量測定

3. FEATURE & DIMENSIONS 特征及尺寸

3.1. PRODUCT DIMENSION 產品尺寸

These connectors shall have the dimensions as shown in drawing.

本產品的相關尺寸參見圖面。

3.2. PCB/PANEL LAYOUT 印刷電路板佈局

The recommended PCB layout is shown in drawing.

本產品適用的 PCB layout 參見圖面。

3.3. BILL OF MATERIAL 材料清單

Harmful material controlling follows the requirements of RoHS. The bill of material is described in drawing.

有害物質控制符合RoHS指令要求。本產品使用的材料參見圖面。



3.4. MECHANICAL & ELECTRICAL CHARACTERISTIC 機械及電氣特性

The connector shall have the mechanical and electrical performance as described in drawing.

本產品的機械及電氣特性參見圖面。

3.5. PACKAGING 包裝

Products shall be packaged according to requirements specified in purchase order for safe delivery; connector container and the packaging method are shown in package specification.

產品可依客戶指定要求包裝，包裝材料與包裝方式參見產品包裝規範。

3.6 RATING CURRENT AND RATING VOLTAGE 額定電流與額定電壓

Rating Current is 2A, rating voltage is 250V AC RMS.

額定電流 2A，額定電壓 250 V AC RMS。

3.7 STORAGE AND OPERATING TEMPERATURE 存貯與使用溫度

Temperature range: $-40^{\circ}\text{C}\sim+105^{\circ}\text{C}$, including terminal temperature rise for rating current.

Storage Temperature : $0^{\circ}\text{C}\sim+40^{\circ}\text{C}$, Humidity: 80%RH under , Time limit is 18 months the products are stored .

溫度範圍： $-40^{\circ}\text{C}\sim+105^{\circ}\text{C}$,包含接觸端子的額定電流溫升。

儲存溫度： $0^{\circ}\text{C}\sim+40^{\circ}\text{C}$ ，濕度：80%RH以下,產品限存時間為18個月。

4. Environmental 環境要求

4.1. SOLDERABILITY 可焊性

Connectors meet solder-ability to EIA-364-52, and shall be free of contaminants.

產品可焊性符合 EIA-364-52 標準規定的相關要求，表面不得有污染物。

4.2. RESISTANCE TO SOLDER HEAT 耐焊接熱

INFRARED REFLOW 紅外線回流焊接

Each cycle consists of three consecutive phases, as shown in **Table III** .

每個焊接週期包括三個連續的階段，見附表三，

5 PERFORMANCE AND TEST DESCRIPTION 性能及測試

5.1. REQUIREMENT 要求

Product is designed to meet electrical, mechanical, and environmental performance requirements specified in **Table I** .

本產品設計符合附表一所列的機械，電氣及環境要求。

5.2. TEST CONDITION 測試條件

Unless otherwise specified, all tests shall be performed at ambient environmental conditions.



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除非特別注明，所有測試在室溫條件下完成。

5.3. SAMPLE SELECTION 樣品選擇

Test samples shall be selected at random from current production. No test samples shall be reused. Samples are pre-conditioned with 10cycles of durability. Each group shall be containing 5 test samples at least.

測試樣品從現生產的產品中隨機抽取，所有測試過的樣品不得重複使用。樣品已預先插拔10次，每組測試至少有5個樣品。

5.4. TEST SEQUENCE 測試順序

Product qualification test sequence as shown in **Table II**.

產品品質測試順序見附表二。

Table I: Test Requirements and Methods

附表一：測試要求與方法

Items 項目	Requirements 要求	Test Methods 測試方法
1. Confirmation of Product 產品確認	Product shall be conforming to the requirements of applicable product drawing. 產品必須符合相關產品圖面的要求。	Visually, dimensions and functionally inspected per applicable product drawing. 依相關產品圖面，檢查產品的外觀、尺寸及功能。
2. Contact Resistance 接觸阻抗	20 mΩ Max. initial; 初始狀態最大 20 mΩ;	Subject mated contacts assembled in housing to closed circuit of 10mA max, at open circuit voltage of 20mV max.Per EIA-364-06. 所述固定在外殼裏的端子連結到一個封閉回路中測試。 测试：电流 10mA, 电压 20mV max. 適用：EIA-364-06.
3. Insulation Resistance 絕緣阻抗	1000 MΩ Min; 最小 1000 MΩ;	Measure by applying test potential between the adjacent contacts, and between the contacts and ground in the mated connector.(500 V DC±10%). Per EIA-364-21 測試產品相鄰端子間以及端子與接地間的電阻，(500 V DC±10%)。適用：EIA-364-21.



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<p>4. Dielectric Withstanding Voltage 耐電壓</p>	<p>Connector must withstand test potential of 1000 V AC RMS for 1 minute, Current leakage must be 0.2mA Max. 样品必須承受測試電壓 1000 V AC RMS，時間 1 分鐘，漏電流不大於 0.2 mA。</p>	<p>Measure by applying test potential between the adjacent contacts, and between the contacts and ground in the mated connector. Per EIA-364-20 對產品相鄰端子間以及端子與接地間加載電壓，並測試其漏電流。適用：EIA-364-20.</p>
<p>5. Durability (Repeated Mating/Un-mating) 耐久性</p>	<p>Contact Resistance: 30mΩ max. after testing. 测试后接触阻抗最大 30mΩ。</p>	<p>Repeat mate and unmated for connector 100 cycles, At a speed of 10 cycles per minute. Per EIA-364-09 重復進行配合產品 100 次插拔。速度每分钟 10 次。適用：EIA-364-09.</p>
<p>6. Contact Pin Mating/Un-mating Force 单支插入力/拔出力,</p>	<p>Mating force: 1N/pin Max. Un-mating force: 0.2N/pin Min. 插入力最大 1N/pin。 拔出力最小 0.2N/pin</p>	<p>At a speed of 25.4±3 mm/minute, apply axial insert the mating part into fully or pull out from the subject product. Per EIA-364-13 以 25.4±3 mm/分鐘的速度，軸向完全插入對配插件到被測產品中或從被測產品中拔出。適用：EIA-364-13</p>
<p>7. Contact Retention Force, 端子保持力,</p>	<p>5N/Pin. Min. 每支最小 5N.</p>	<p>Apply axial pull out force at a speed of 25.4±3 mm/minute on the contact assembled in the housing. Per EIA-364-29 以 25.4±3mm/分鐘的速度施加軸向拉力從塑膠本體上拔出端子。適用：EIA-364-29</p>
<p>8. Vibration Sinusoidal Low Frequency 低頻正弦振動</p>	<p>No electrical discontinuity greater than 1 μ sec(s) shall occur. Contact resistance: 30 mΩ max. 不允许出现 1 μ sec(s)的瞬间断开， 接触阻抗：30 mΩ 最大。</p>	<p>Subject mated connector to 10-55-10 Hz traversed in 1 minute at 1.52 mm amplitude, 2 hours each of 3 mutually perpendicular planes, 10 mA applied. Per EIA-364-28 對測試產品，在頻率變化每分鐘從 10-55-10 Hz, 振幅 1.52 mm 條件下，在互相垂直的三個面上，每個面 2 小時下測量，電流 10 mA。 適用：EIA-364-28</p>
<p>9. Thermal Shock 熱衝擊</p>	<p>After testing, no damage, contact Resistance 30mΩ max, Dielectric Strength should be OK, Insulation should be 1000MΩ min. 测试后，产品无损坏，接触阻抗：30mΩ 最大；耐电压测试 OK，绝缘阻抗：1000MΩ 最小。</p>	<p>Temperature range from -55°C to +85°C. Start from -55°C, after 30 minutes, change to +85°C; change time is no more than 30 seconds, total 5 cycles. Per EIA-364-32 溫度變化範圍：-55°C~ +85°C。從 -55°C 開始，30 分鐘後換到+85°C，轉換時間不超過 30 秒，共 5 個循環。適用：EIA-364-32</p>
<p>10. Humidity (Steady State) 恆溫恆濕</p>	<p>After testing, no damage, Contact resistance 30mΩ max, Dielectric strength should be OK, Insulation Resistance should be 1000MΩ min. 测试后，无损坏，接触阻抗：30mΩ 最大，耐压测试 OK，绝缘阻抗：1000MΩ 最小。</p>	<p>Temperature: 40±2°C, Relative Humidity: 90-95%. Duration: 96 hours. Per EIA-364-31 溫度：40±2°C。 相對濕度：90-95%。 持續時間：96 小時。 適用：EIA-364-31</p>



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<p>11. Salt Spray 鹽霧</p>	<p>After testing, no damage, Contact resistance 30mΩ max, Dielectric. Strength should be OK, Insulation Resistance should be 1000MΩ min. 测试后, 产品无损坏, 接触阻抗: 30mΩ 最大; 耐电压测试 OK, 绝缘阻抗: 1000MΩ 最小。</p>	<p>5±1% salt concentration 48 hours 35±2°C Per EIA-364-26 鹽水濃度 5±1%, 時間 48 小時, 溫度 35±2°C。 適用: EIA-364-26。</p>
<p>12. Solder-ability 可焊性</p>	<p>Appearance of the specimen shall be inspected after the test with the assistance of magnifier capable of giving a magnification of 10X for any damage such as pin holes, void or rough surface. 产品的测试完成后, 的放大 10 倍的显微镜下, 检查外观损坏如: 小孔, 空焊或外观粗糙度。</p>	<p>Soldering time: 5 seconds, Temperature: 245±5°C, Per EIA-364-52 焊接时间: 5 秒, 温度: 245±5°C, 适用: EIA-364-52</p>
<p>13. High Temperature Life 高溫老化</p>	<p>After testing, no damage, Contact resistance 30mΩ max, Dielectric. Strength should be OK, Insulation Resistance should be 1000MΩ min. 测试后, 产品无损坏, 接触阻抗: 30mΩ 最大; 耐电压测试 OK, 绝缘阻抗: 1000MΩ 最小。</p>	<p>Subject product to 105±2°C for 96 hours continuously. Per EIA-364-17 產品置於 105±2°C 連續 96 小時。 適用: EIA-364-17。</p>

Table II: Product Qualification Test Sequence

附表二：產品測試順序

Test Description 測試描述	Test Group 測試分組							
	A	B	C	D	E	F	G	H
1. Conformation of Product 產品確認	1,7	1,4	1,9	1,9	1,9	1,3	1,9	1,9
2. Contact Resistance 接觸阻抗	2,6		2,6	2,6	2,6		2,6	2,6
3. Insulation Resistance 絕緣阻抗	3		3,7	3,7	3,7		3,7	3,7
4. Dielectric Withstanding Voltage 耐電壓	4		4,8	4,8	4,8		4,8	4,8
5. Durability(Repeated Mating/Un-mating) 耐久性	5							
6. Mating/Un-mating Force 插入/拔出力		2						
7. Contact Retention Force 端子保持力		3						
8. Vibration Sinusoidal Low Frequency 低頻正弦振動			5					
9. Thermal Shock 熱衝擊				5				
10. Humidity (Steady State) 恆溫恆濕					5			
11. Solder ability 可焊性						2		
12. Salt Spray 鹽霧							5	
13. High Temperature Life 高溫老化								5

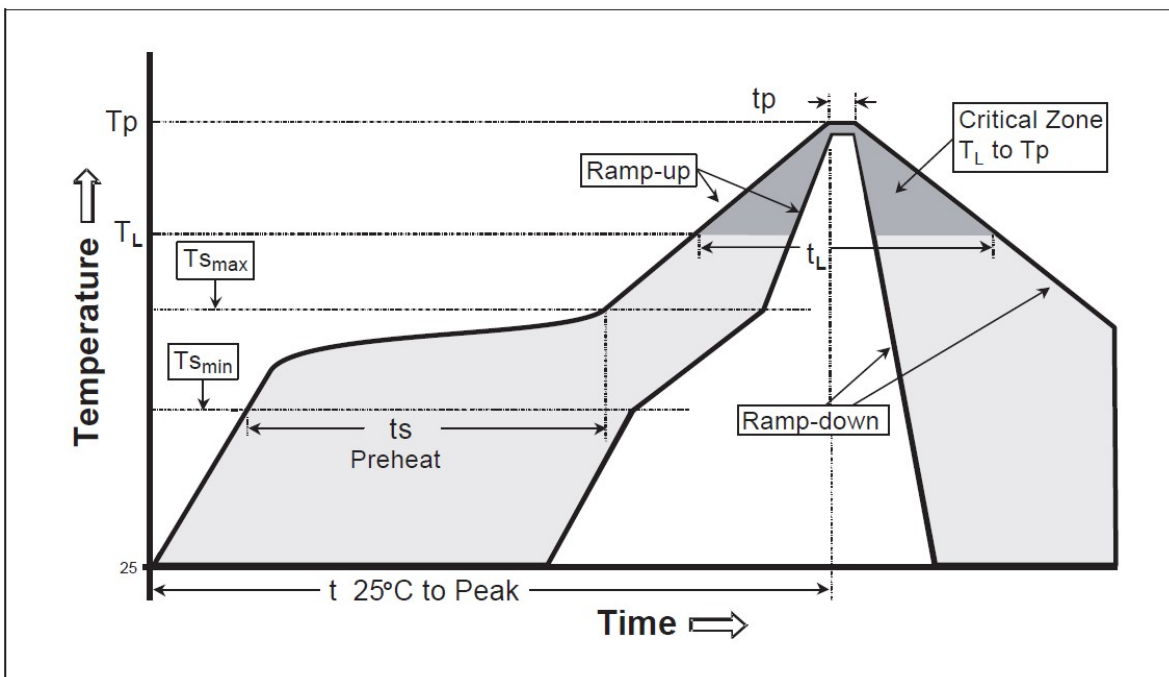
Table II: Reflow Soldering Profile

附表三：回流焊接曲線圖 II

Lead-free reflow profile requirements:

無鉛回流焊接曲線

Parameter 参数	Reference 参考	Specificati on
升溫區 Ramp-up	25°C ~150°C	3°C/S Max
預熱區 Pre-heating	150°C ~200°C	60~180sec
過早區 Reflow	217°C	60~150sec
Peak Temp(T_p)	260-/+5°C	20~40sec
Time 25°C to T_p	25°C ~ Peak Temp.	8 minutes maximum
冷卻區 Cooling	Peak Temp.~150°C	-6°C/S(Max)



This profile is the minimum requirement for evaluating soldering heat resistance of components. Heat transfer method used for reflow soldering is hot air convection. The actual air temperatures used to achieve the specified profile largely dependent on the reflow equipment.

這個曲線圖是評估元件器件焊接抗熱的基本要求。應用在對焊接中的熱傳遞方式是熱氣對流。達到特定曲線圖地實際溫度主要依賴與回流焊接備。